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## BIB DATA SHEET

CONFIRMATION NO. 7420

<b>SERIAL NUMBER</b> 10/772,311	<b>FILING or 371(c) DATE</b> 02/06/2004 <b>RULE</b>	<b>CLASS</b> 264	<b>GROUP ART UNIT</b> 1791	<b>ATTORNEY DOCKET NO.</b> 2557-000220/US		
<b>APPLICANTS</b> Sang-Hyeop Lee, Cheonan-si, KOREA, REPUBLIC OF; Hee-Kook Choi, Cheonan-si, KOREA, REPUBLIC OF; Cheol-Joon Yoo, Cheonan-si, KOREA, REPUBLIC OF; <b>** CONTINUING DATA *****</b> <b>** FOREIGN APPLICATIONS *****</b> REPUBLIC OF KOREA 2003-9361 02/14/2003 REPUBLIC OF KOREA 2003-31152 05/16/2003 <b>** IF REQUIRED, FOREIGN FILING LICENSE GRANTED **</b> 05/05/2004						
Foreign Priority claimed <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No 35 USC 119(a-d) conditions met <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No Verified and Acknowledged <u>/EDMUND H LEE/</u> Examiner's Signature		<input type="checkbox"/> Met after Allowance Initials	<b>STATE OR COUNTRY</b> KOREA, REPUBLIC OF	<b>SHEETS DRAWINGS</b> 6	<b>TOTAL CLAIMS</b> 16	<b>INDEPENDENT CLAIMS</b> 3
<b>ADDRESS</b> HARNESS, DICKEY & PIERCE, P.L.C. P.O. BOX 8910 RESTON, VA 20195 UNITED STATES						
<b>TITLE</b> MOLDING METHOD FOR ENCAPSULATING BOTH SIDES OF PCB MODULE WITH WAFER LEVEL PACKAGE MOUNTED PCB						
<b>FILING FEE RECEIVED</b> 770	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:			<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit		